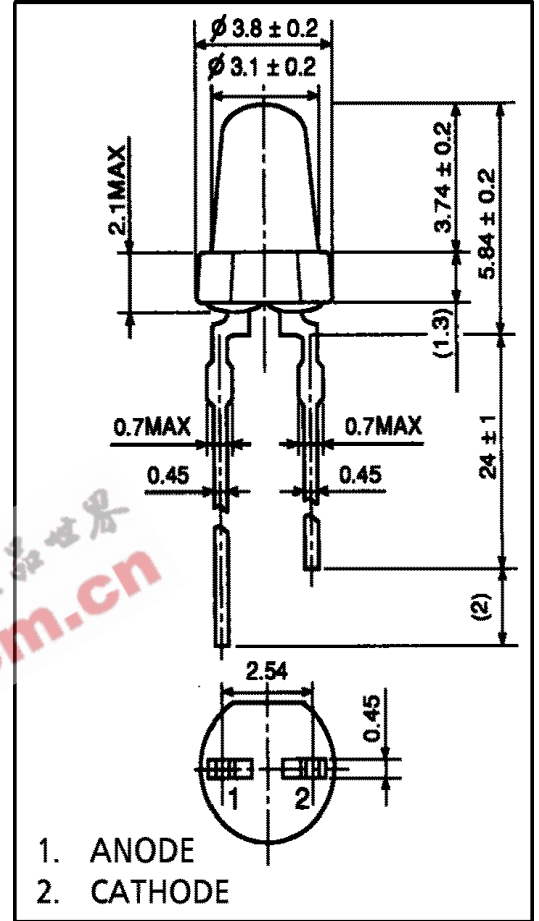


Features

3.1mm Package
 InGaAlP Technology
 All Plastic Mold Type
 Water Clear Lens
 Fast Response Time, Capable of Pulse Operation
 High Power Luminous Intensity

Applications

Suitable for Safety equipment
 Outdoor displays



Series Line-Up

Part Number	Color	Material
TLGE160	Ultra Bright Yellow Green	InGaAlP
TLOE160A	Ultra Bright Orange	InGaAlP
TLPGE160	Ultra Pure Green	InGaAlP
TLRE160A	Ultra Bright Red	InGaAlP
TLYE160A	Ultra Bright Yellow	InGaAlP

Maximum Ratings (Ta=25°C)

Part Number	Forward Current I _F	Reverse Voltage V _R	Power Dissipation P _D	Operating Temperature T _{opr}	Storage Temperature T _{stg}
TLGE160	50	4	140.00	-30 ~ 85	-40 ~ 120
TLOE160A	50	4	125.00	-30 ~ 85	-40 ~ 120
TLPGE160	50	4	140.00	-30 ~ 85	-40 ~ 120
TLRE160A	50	4	125.00	-30 ~ 85	-40 ~ 120
TLYE160A	50	4	125.00	-30 ~ 85	-40 ~ 120
Unit	mA	V	mW	°C	°C

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 950 South Coast Drive, Suite 265
 Costa Mesa, California 92626
 Toll Free: 800.984.5337
 Fax: 714.850.9314

Electrical and Optical Characteristics (Ta=25°C)

Part Number	PWL nm λ_P	Material	View Angle $2\theta_{1/2}$	Luminous Intensity I_v				Forward Voltage V_F				Rev Current I_R	
				min.	typ.	max.	IF@	min.	typ.	max.	IF@	max.	VR@
TLGE160	574	InGaAIP	9°	850.00	2400.00	–	20mA	–	2.27	2.80	20mA	50	4V
TLOE160A	612	InGaAIP	10°	476.00	1500.00	–	20mA	–	1.95	2.40	20mA	50	4V
TLPGE160	562	InGaAIP	9°	272.00	450.00	–	20mA	–	2.27	2.80	20mA	50	4V
TLRE160A	644	InGaAIP	10°	476.00	1200.00	–	20mA	–	1.85	2.40	20mA	50	4V
TLYE160A	590	InGaAIP	10°	476.00	2300.00	–	20mA	–	2.10	2.50	20mA	50	4V
–	nm	–	deg	mcd				–	V		–	μ A	–

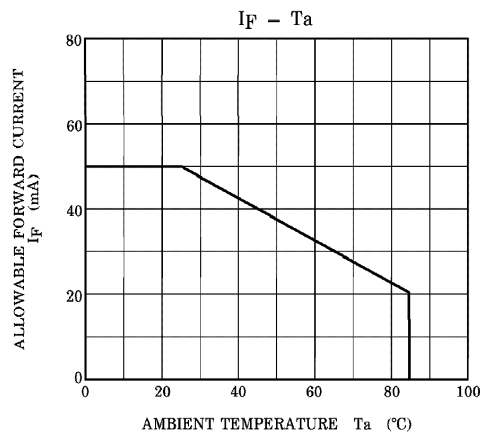
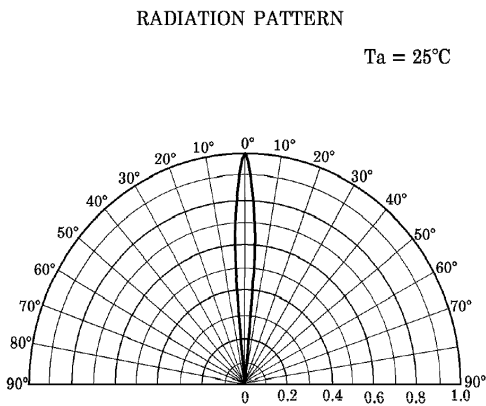
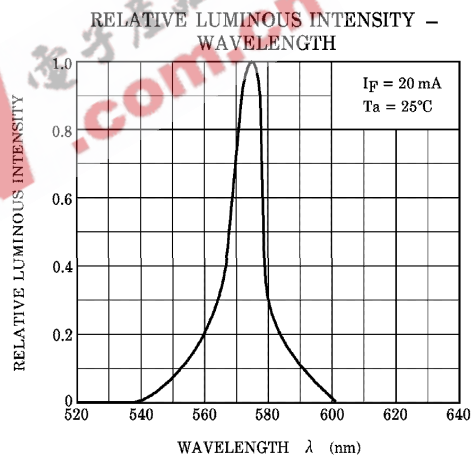
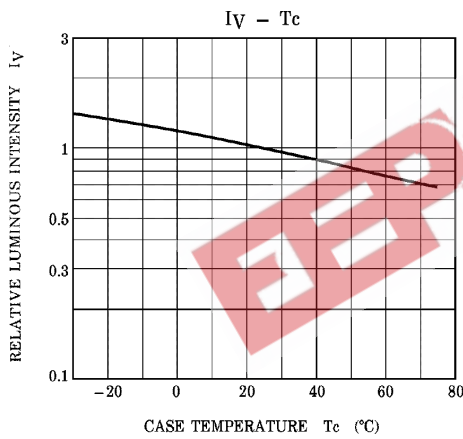
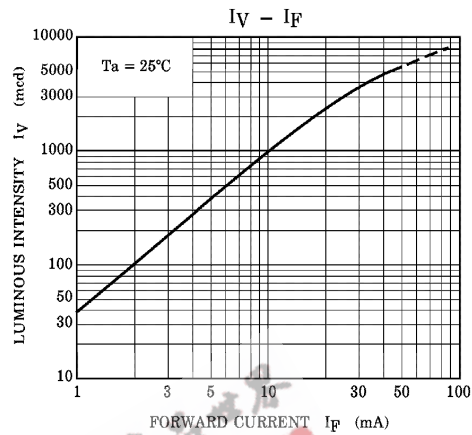
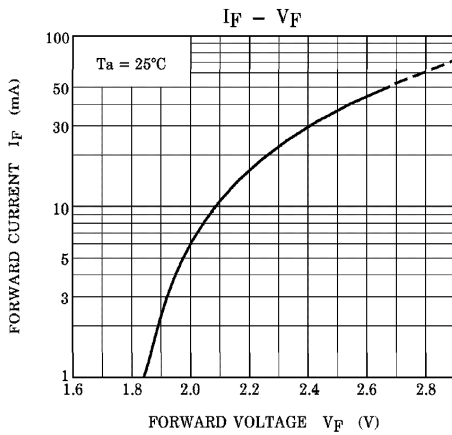
Precautions

- Soldering temperature: 260°C max, soldering time: 3 s max (soldering portion of lead: up to 2 mm from the body of the device).
- If the lead is formed, the lead should be formed up to 5 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

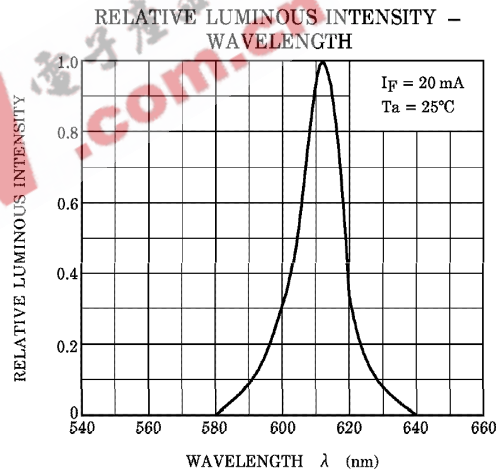
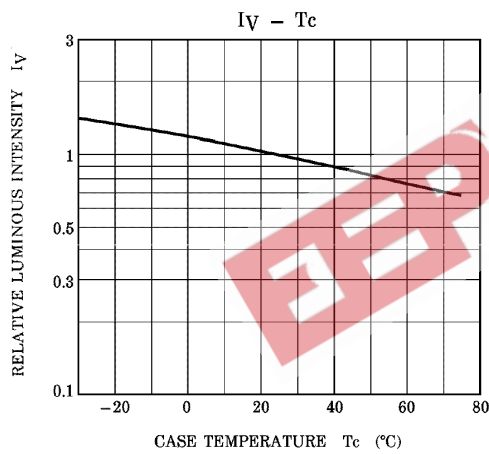
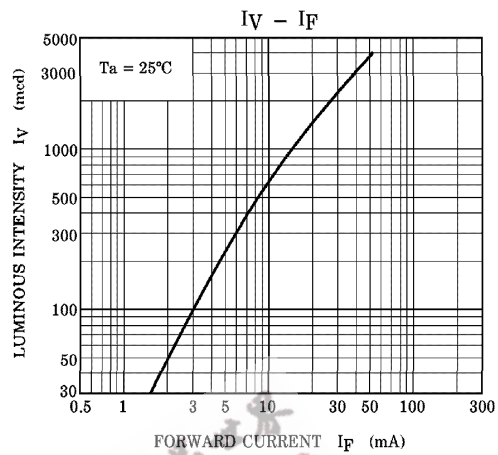
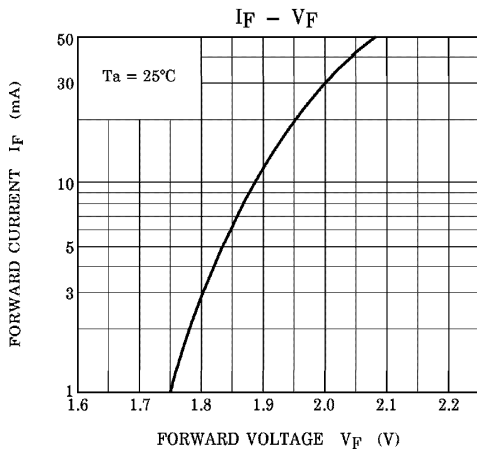
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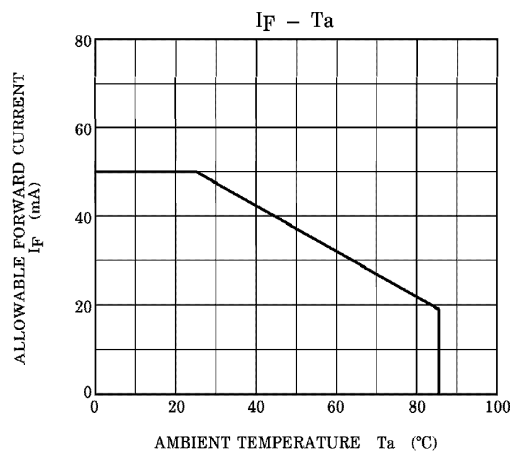
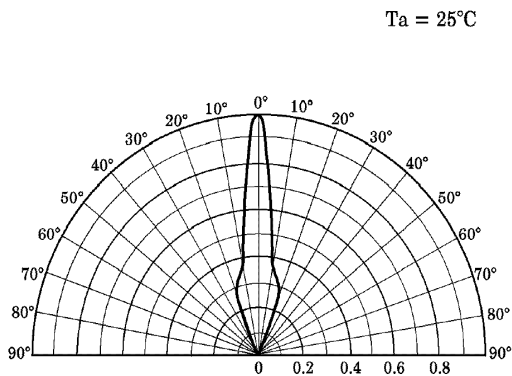
TLGE160 Graphs



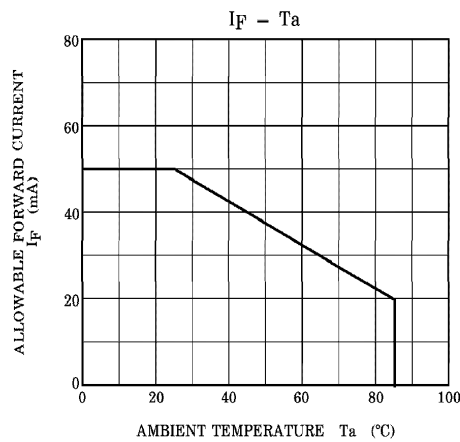
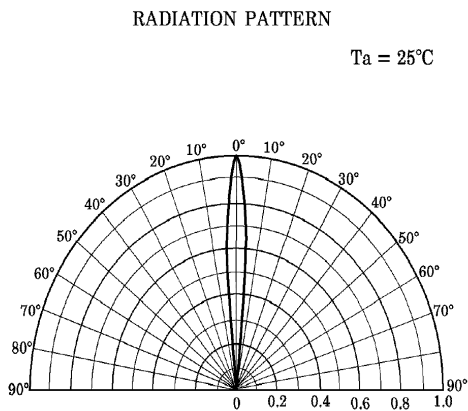
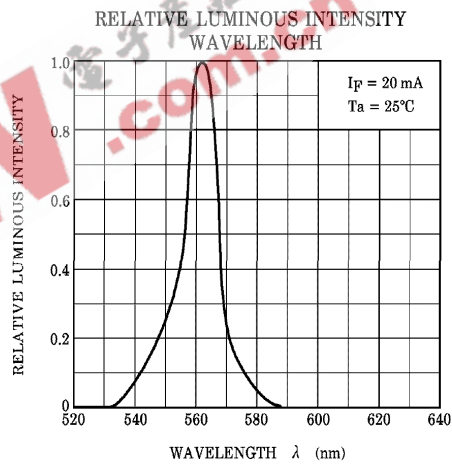
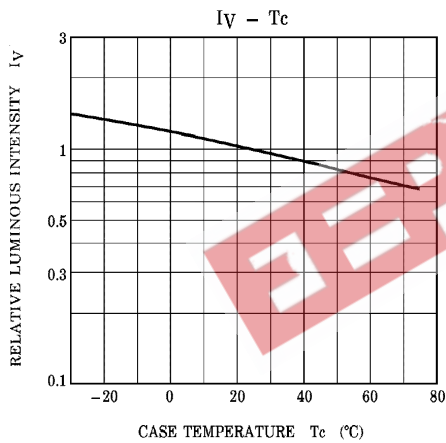
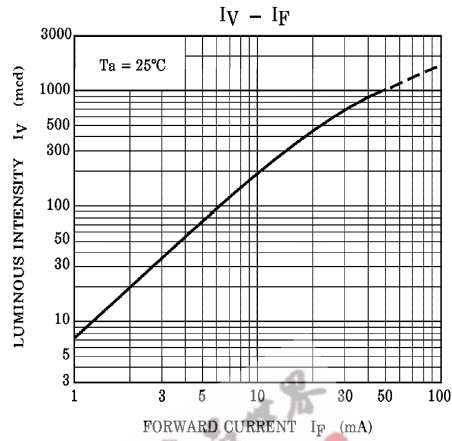
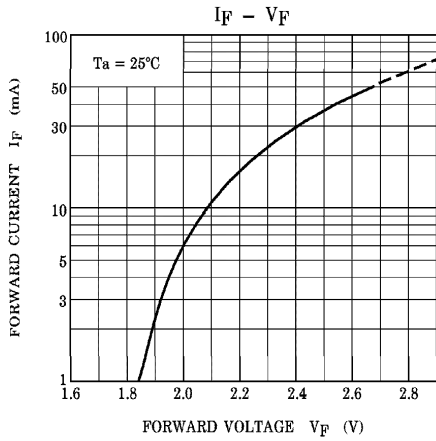
TLOE160A Graphs



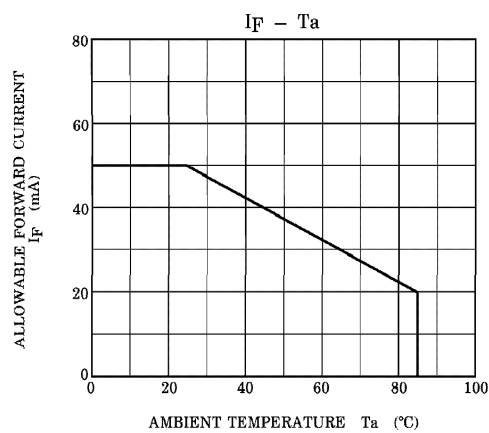
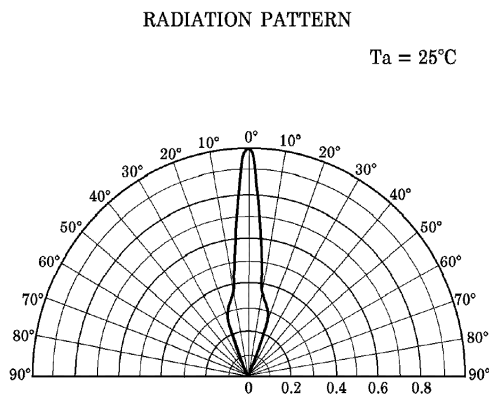
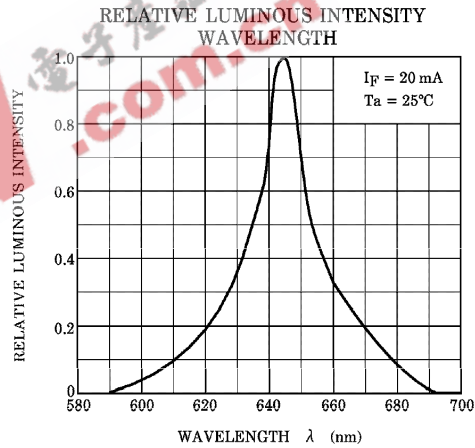
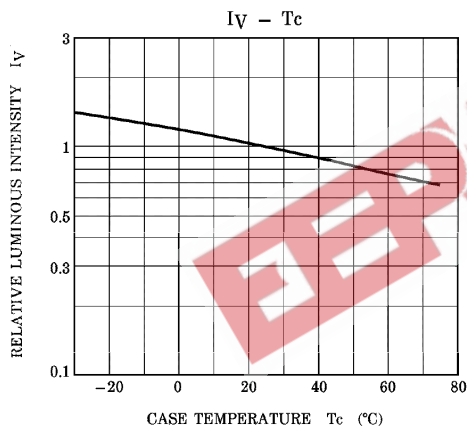
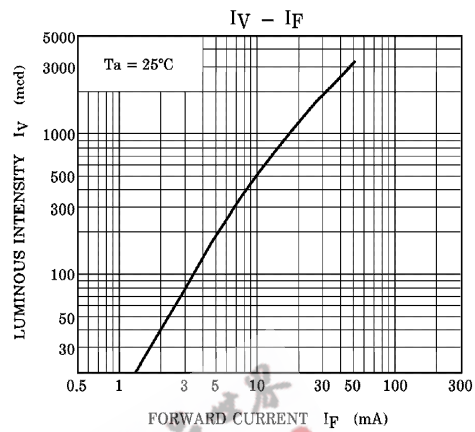
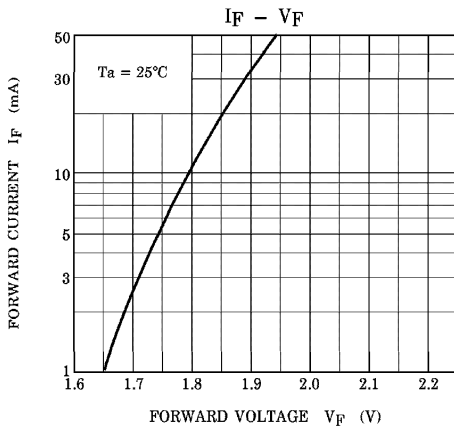
RADIATION PATTERN



TLPGE160 Graphs



TLRE160A Graphs



TLYE160A Graphs

